

70V N-Channel Trench MOSFET(Preliminary)

General Description				
 Trench Power technology Low R_{DS(ON)} Low Gate Charge Optimized for fast-switching applications 		V_{DS} I _D (at V _{GS} =10V) R _{DS(ON)} (at V _{GS} =10V)	68V 70A < 10.8mΩ	
 Applications Synchronous Rectification in DC/DC and AC/DC Converters Isolated DC/DC Converters in Telecom and Industrial 			100% UIS Tested	
	TO-252 G D	S	G G S	
Part Number	Packag	де Туре	Form	Marking
TTD70N07A	ТО-	-252	Tape&Reel	70N07A
	tings (T _A =25	5ºC unless o Symbol	therwise noted) Maximum	Units
Parameter	tings (T _A =25	1		Units V
Parameter Drain-Source Voltage	tings (T _A =25	Symbol	Maximum	
Parameter Drain-Source Voltage Gate-Source Voltage	T _C =25°C	Symbol V _{DS}	Maximum 40 ±20 46	V
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current ^B		Symbol V _{DS} V _{GS}	Maximum 40 ±20	V V
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current ^B Pulsed Drain Current ^A	T _C =25°C	Symbol V _{DS} V _{GS}	Maximum 40 ±20 46 46	V V A
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current	T _C =25°C	Symbol V _{DS} V _{GS} I _D I _{DM}	Maximum 40 ±20 46 46 210	V V A A
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy	T _C =25°C T _C =100°C	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS}	Maximum 40 ±20 46 210 23	V V A A A A
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy	T _c =25°C T _c =100°C L =0.3mH ^A	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS}	Maximum 40 ±20 46 210 23 79	V V A A A A mJ
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy Power Dissipation	$T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ $L = 0.3mH^{A}$ $T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS}	Maximum 40 ±20 46 210 23 79 120	V V A A A A mJ W
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy Power Dissipation C Junction and Storage Temperatu	$T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ $L = 0.3mH^{A}$ $T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS} P _D	Maximum 40 ±20 46 210 23 79 120 60	V V A A A M M W W
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy Power Dissipation C Junction and Storage Temperatu	$T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ $L = 0.3mH^{A}$ $T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS} P _D	Maximum 40 ±20 46 210 23 79 120 60	V V A A A M M W W
Pulsed Drain Current ^A Avalanche Current ^A Single Pulse Avalanche Energy Power Dissipation ^C Junction and Storage Temperatu Thermal Characteristics	$T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ $L = 0.3mH^{A}$ $T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS} P _D T _J , T _{STG}	Maximum 40 ±20 46 46 210 23 79 120 60 -55 to 175	V V A A A M M W W W V V



	cal Characteristics(T _J =25ºC ur	1	,				
Symbol	Parameter	Conditions			Value		Units
				Min	Тур	Max	
STATIC P	ARAMETERS	1			1		
BV_{DSS}	Drain-Source Breakdown Voltage	I _D =250µA,V _{GS} =0V		40			V
	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V	T _J =25°C			1	μA
I _{DSS}	Zero Gale voltage Drain Current		T _J =100°C			25	
I _{GSS}	Gate-Body Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$				±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA		2	3	4	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =30A			8.5	10.8	mΩ
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =30A			17.1		S
V _{SD}	Diode Forward Voltage	I _S =30A, V _{GS} =0V				1	V
I _S	Maximum Body-Diode Continuous Curre	rent ^B				46	А
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, f =1MH _z			4570		pF
C _{oss}	Output Capacitance				1410		
C _{rss}	Reverse Transfer Capacitance				734		
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =20V, I _D =40A			70		nC
Q_{gs}	Gate Source Charge				20		
Q_{gd}	Gate Drain Charge				17		
t _{D(on)}	Turn-On Delay Time	$V_{GS} = 10V, V_{DS} = 20V, I_{D} = 40A,$ $R_{G} = 2.5\Omega$			8		- ns
t _r	Turn-On Rise Time				7		
T _{D(off)}	Turn-Off Delay Time				40		
t _f	Turn-Off Fall Time				15		
t _{rr}	Body Diode Reverse Recovery Time		10		30		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =20A, di/dt =100A/μs			45		nC

A. Single pulse width limited by maximum junction temperature.

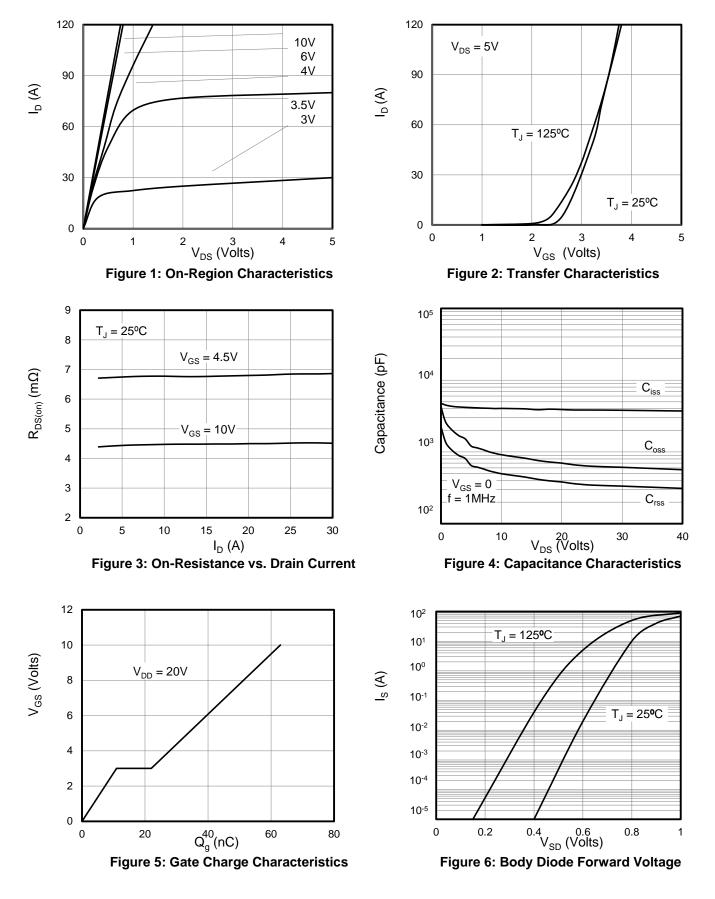
- B. The maximum current rating is package limited.
- C. The power dissipation P_D is based on $T_{J(MAX)} = 175^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

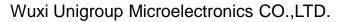
TTD70N07A



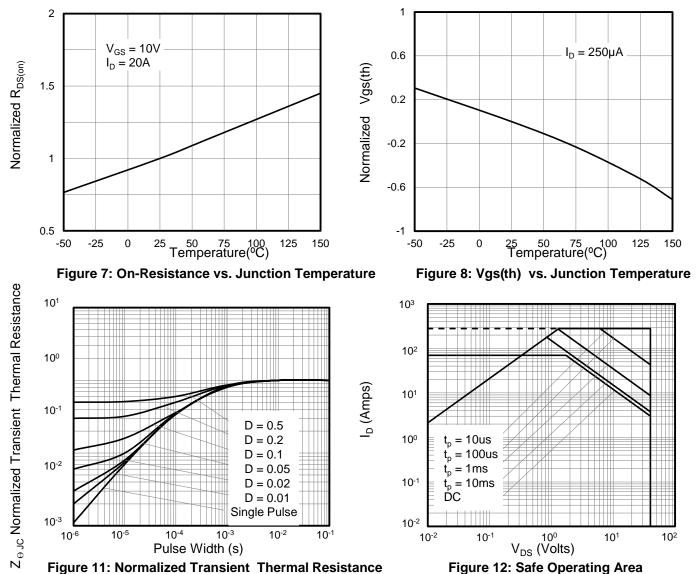
Wuxi Unigroup Microelectronics CO.,LTD.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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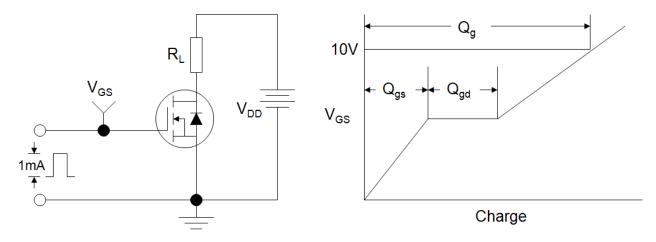


Figure A: Gate Charge Test Circuit and Waveforms

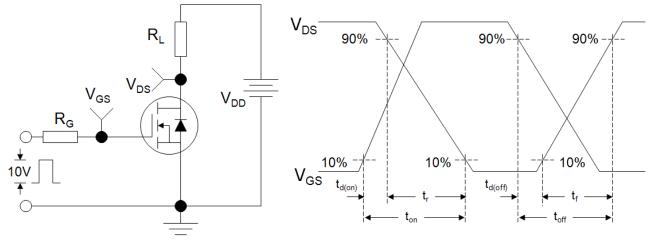


Figure B: Resistive Switching Test Circuit and Waveforms

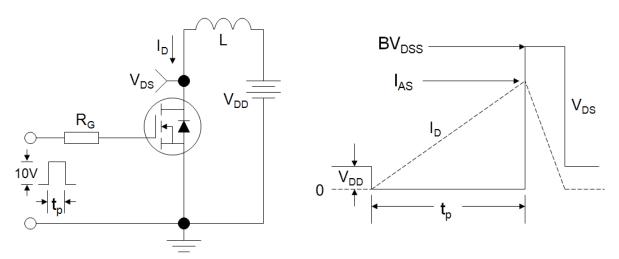
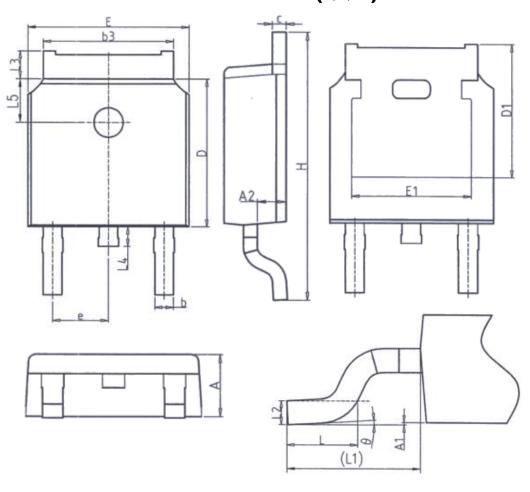


Figure C: Unclamped Inductive Switching (UIS) Test Circuit and Waveforms



TO-252(华天)



Unit: mm				
Symbol	Min.	Max.		
Α	2.20	2.40		
A1	0.00	0.20		
A2	0.97	1.17		
b	0.68	0.90		
b3	5.20	5.50		
с	0.43	0.63		
D	5.98	6. 22		
D1	5. 30REF			
E	6.40	6.80		
E1	4.63	-		

Unit: mm				
Symbol	Min.	Max.		
e	2. 286BSC			
H	9.40	10.50		
L	1.38	1.75		
L1	2. 90REF			
L2	0. 51BSC			
L3	0.88	1.28		
L4	_	1.00		
L5	1.65	1.95		
θ	0°	8°		



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